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# **1 Maximum ratings** at *T*<sub>A</sub>=25 °C, unless otherwise specified

## Table 2Maximum ratings

	Sumbal		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit		
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- -	132 83 19	A	$V_{GS}$ =10 V, $T_{C}$ =25 °C $V_{GS}$ =10 V, $T_{C}$ =100 °C $V_{GS}$ =10V, $T_{A}$ =25°C, $R_{thJA}$ =50 K/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	528	A	<i>T</i> <sub>c</sub> =25 °C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	220	mJ	I <sub>D</sub> =50 A, <i>R</i> <sub>GS</sub> =25 Ω	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	125 2.5	w	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 **Thermal characteristics**

#### Table 3 **Thermal characteristics**

Devementer	Sumbal	Values			11:0:4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	-	-	1.0	K/W	-	
Thermal resistance, junction - case, top	R <sub>thJC</sub>	-	-	18	K/W	-	
Device on PCB, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-	
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	50	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. <sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air. <sup>3)</sup> See Diagram 3 for more detailed information



# **3** Electrical characteristics at *T*<sub>j</sub>=25 °C, unless otherwise specified

#### Table 4 **Static characteristics**

Parameter	Symphol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit		
Drain-source breakdown voltage	$V_{(BR)DSS}$	75	-	-	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.3	3.1	3.8	V	V <sub>DS</sub> =V <sub>GS</sub> , <i>I</i> <sub>D</sub> =91 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1.0 100	μA	V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	3.7	4.2	mΩ	V <sub>GS</sub> =10 V, <i>I</i> <sub>D</sub> =50 A	
Gate resistance	R <sub>G</sub>	-	2.2	-	Ω	-	
Transconductance	$g_{ m fs}$	44	89	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =50 A	

#### Table 5 **Dynamic characteristics**

Demonster	Complete L		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	Ciss	-	3600	4800	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =37.5 V, <i>f</i> =1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	810	1100	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =37.5 V, <i>f</i> =1 MHz	
Reverse transfer capacitance	Crss	-	40	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =37.5 V, <i>f</i> =1 MHz	
Turn-on delay time	t <sub>d(on)</sub>	-	14	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$	
Rise time	tr	-	17	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$	
Turn-off delay time	$t_{\rm d(off)}$	-	34	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$	
Fall time	t <sub>f</sub>	-	9	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$	

#### Gate charge characteristics<sup>2)</sup> Table 6

Devenenter	Sumph al		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	18.3	-	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Gate to drain charge	Q <sub>gd</sub>	-	10.4	-	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	17.6	-	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	Qg	-	52	69	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.1	-	V	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	53	71	nC	V <sub>DD</sub> =37.5 V, V <sub>GS</sub> =0 V	

 $^{1)}$  Defined by design. Not subject to production test  $^{2)}$  See "Gate charge waveforms" for parameter definition

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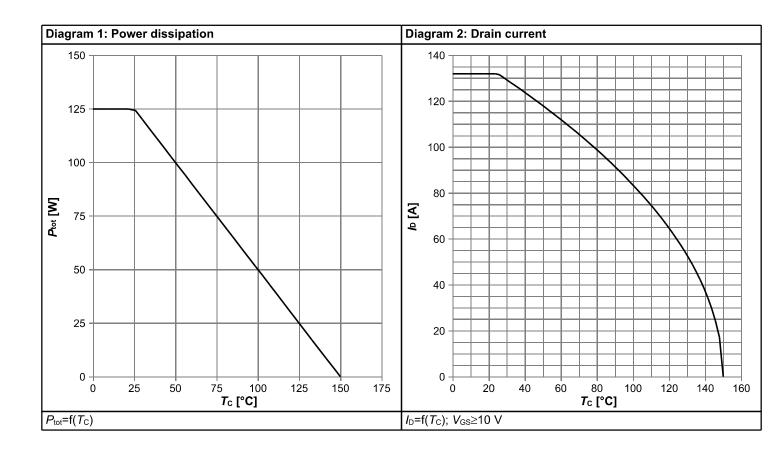


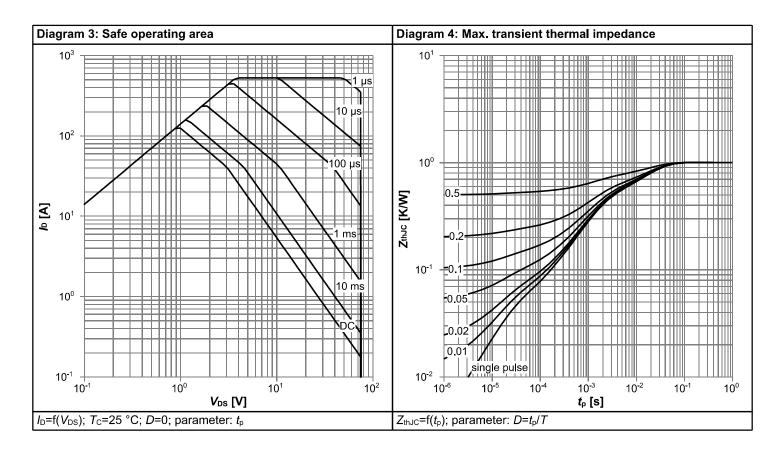
# Table 7 Reverse diode

Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	ls	-	-	90	A	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	528	A	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.89	1.2	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>F</sub> =50 A, <i>T</i> <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	44	-	ns	V <sub>R</sub> =40 V, <i>I</i> <sub>F</sub> =25A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge	Qrr	-	64	-	nC	V <sub>R</sub> =40 V, <i>I</i> <sub>F</sub> =25A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

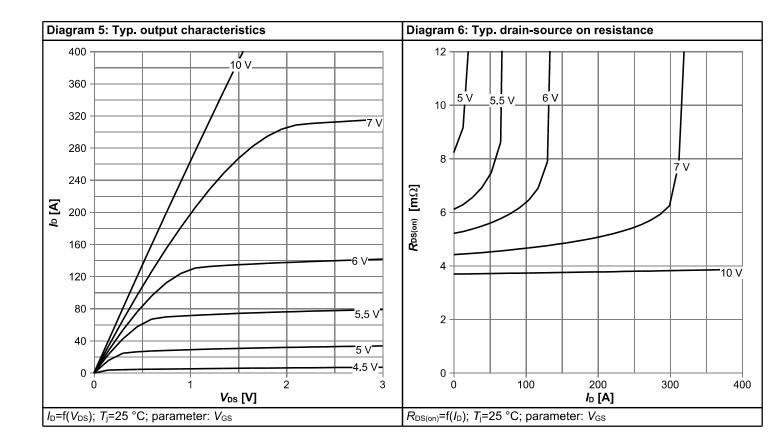


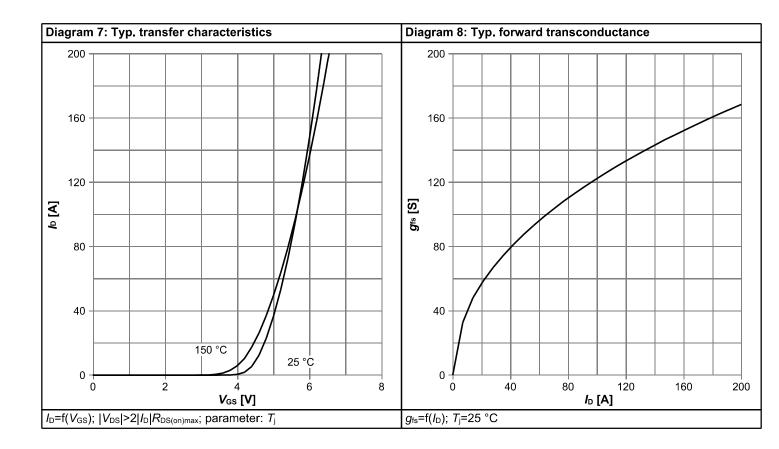
# 4 Electrical characteristics diagrams



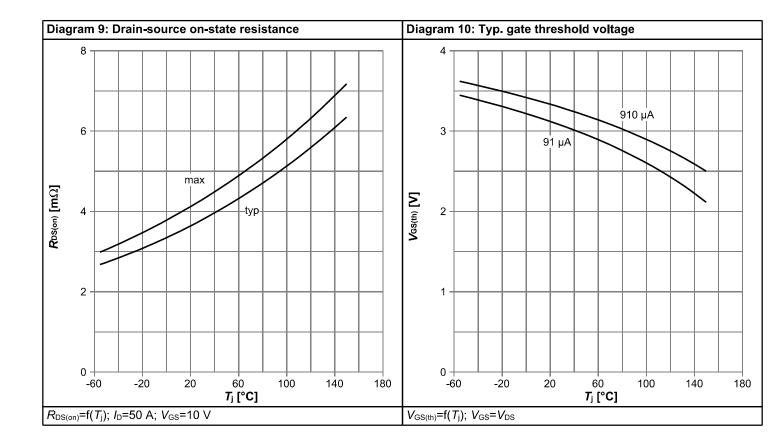


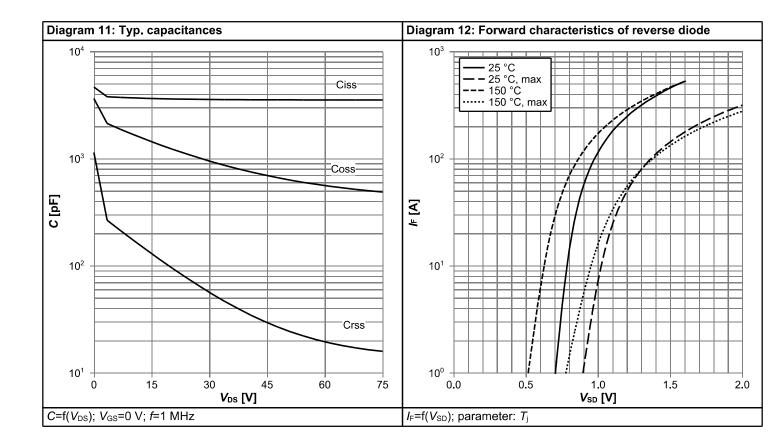




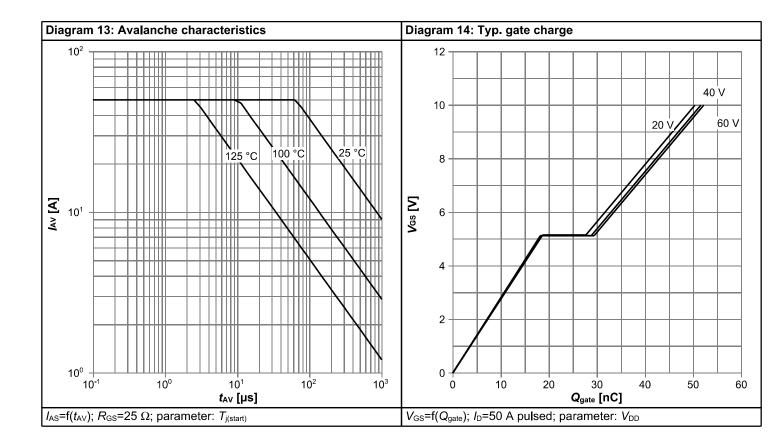


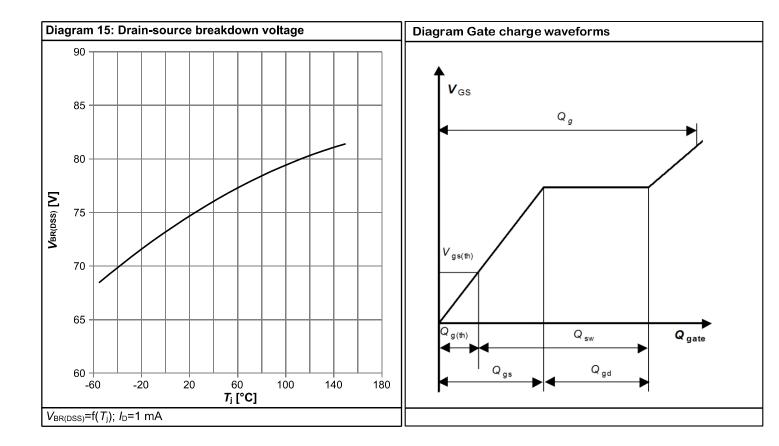






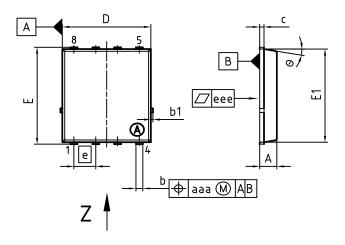


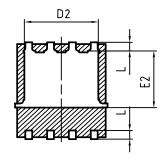


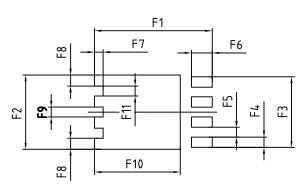


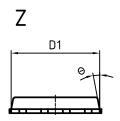


# 5 Package Outlines









DIM	MILLIN	IETERS	INC	IES		
	MIN	MAX	MIN	MAX		
Α	0.90	1.10	0.035	0.043		
b	0.34	0.54	0.013	0.021		
b1	0.02	0.22	0.001	0.008		
с	0.15	0.35	0.006	0.014		
D=D1	4.95	5.35	0.195	0.211		
D2	4.20	4.40	0.165	0.173		
E	5.95	6.35	0.234	0.250		
E1	5.70	6.10	0.224	0.240		
E2	3.40	3.80	0.134	0.150		
е	1.:	27	0.0	50		
N		8	8			
L	0.45	0.65	0.018	0.026		
Θ	8.5°	11.5°	8.5°	11.5°		
aaa	0.	25	0.0	10		
eee	0.	0.05		02		
F1	6.75	6.95	0.266	0.274		
F2	4.60	4.80	0.181	0.189		
F3	4.36	4.56	0.172	0.180		
F4	0.55	0.75	0.022	0.030		
F5	0.52	0.72	0.020	0.028		
F6	1.10	1.30	0.043	0.051		
F7	0.40	0.60	0.016	0.024		
F8	0.60	0.80	0.024	0.031		
F9	0.53	0.73	0.021	0.029		
F10	4.90	5.10	0.193	0.201		
F11	0.53	0.73	0.021	0.029		

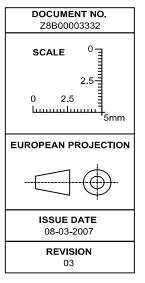


Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



## **Revision History**

BSC042NE7NS3 G

### Revision: 2021-05-10, Rev. 2.3

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.3	2021-05-10	Update current rating and footnotes				

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